

74VHCT00A Quad 2-Input NAND Gate

Features

- High speed: t_{PD} = 5.0ns (Typ.) at T_A = 25°C
- High noise immunity: V_{IH} = 2.0V, V_{II} = 0.8V
- Power down protection is provided on all inputs and outputs
- Low noise: V_{OLP} = 0.8V (Max.)
- Low power dissipation: I_{CC} = 2A (Max.) at T_A = 25°C
- Pin and function compatible with 74HCT00

General Description

The VHCT00A is an advanced high-speed CMOS 2-Input NAND Gate fabricated with silicon gate CMOS technology. It achieves the high-speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation. The internal circuit is composed of 3 stages, including buffer output, which provide high noise immunity and stable output.

Protection circuits ensure that 0V to 7V can be applied to the input pins without regard to the supply voltage and to the output pins with $V_{CC} = 0V$. These circuits prevent device destruction due to mismatched supply and input/ output voltages. This device can be used to interface 3V to 5V systems and two supply systems such as battery backup.

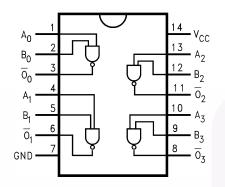
Ordering Information

Order Number	Package Number	Package Description
74VHCT00AM	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74VHCT00ASJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74VHCT00AMTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

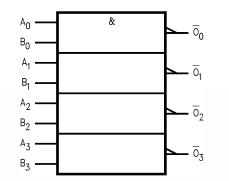
Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.

Connection Diagram



Logic Symbol



Pin Description

Pin Names	Description					
A _n , B _n	Inputs					
Ō _n	Outputs					

Truth Table

Α	В	ō
L	L	Н
L	Н	Н
Н	L	Н
Н	Н	L

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	-0.5V to +7.0V
V _{IN}	DC Input Voltage	-0.5V to +7.0V
V _{OUT}	DC Output Voltage	
	Note 1	–0.5V to V _{CC} + 0.5V
	Note 2	–0.5V to 7.0V
I _{IK}	Input Diode Current	–20mA
I _{OK}	Output Diode Current ⁽³⁾	±20mA
I _{OUT}	DC Output Current	±25mA
I _{CC}	DC V _{CC} /GND Current	±50mA
T _{STG}	Storage Temperature	–65°C to +150°C
ΤL	Lead Temperature (Soldering, 10 seconds)	260°C

Recommended Operating Conditions⁽⁴⁾

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	4.5V to +5.5V
V _{IN}	Input Voltage	0V to +5.5V
V _{OUT}	Output Voltage	
	Note 1	0V to V _{CC}
	Note 2	0V to 5.5V
T _{OPR}	Operating Temperature	–40°C to +85°C
t _r , t _f	Input Rise and Fall Time, $V_{CC} = 5.0V \pm 0.5V$	0ns/V ~ 20ns/V

Notes:

1. HIGH or LOW state. $I_{\mbox{OUT}}$ absolute maximum rating must be observed.

2. $V_{CC} = 0V$.

3. $V_{OUT} < GND$, $V_{OUT} > V_{CC}$ (Outputs Active).

4. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

					т	A = 25°	С		–40°C 85°C	
Symbol	Parameter	V _{CC} (V)	Con	ditions	Min.	Тур.	Max.	Min.	Max.	Units
V _{IH}	HIGH Level Input	4.5			2.0			2.0		V
	Voltage	5.5			2.0			2.0		
V _{IL}	LOW Level Input	4.5					0.8		0.8	V
	Voltage	5.5					0.8		0.8	
V _{OH}	HIGH Level Output	4.5		I _{OH} =50μA	4.40	4.50		4.40		V
	Voltage		or V _{IL}	$I_{OH} = -8mA$	3.94			3.80		
V _{OL}	LOW Level Output	4.5		I _{OL} = 50μA		0.0	0.1		0.1	V
	Voltage		or V _{IL}	$I_{OL} = 8mA$			0.36		0.44	
I _{IN}	Input Leakage Current	0 – 5.5	V _{IN} = 5.5V	or GND			±0.1		±1.0	μA
I _{CC}	Quiescent Supply Current	5.5	$V_{IN} = V_{CC}$	or GND			2.0		20.0	μA
I _{CCT}	Maximum I _{CC} /Input	5.5	$V_{IN} = 3.4V$ Inputs = V ₀	, Other _{CC} or GND			1.35		1.50	mA
I _{OFF}	Output Leakage Current (Power Down State)	0.0	V _{OUT} = 5.5	5V			0.5		5.0	μA

Noise Characteristics

				T _A =	25°C	
Symbol	Parameter	Conditions	V _{CC} (V)	Тур.	Limit	Units
V _{OLP} ⁽⁵⁾	Quiet Output Maximum Dynamic V _{OL}	$C_L = 50 pF$	5.0	0.4	0.8	V
V _{OLV} ⁽⁵⁾	Quiet Output Minimum Dynamic V _{OL}	$C_L = 50 pF$	5.0	-0.4	-0.8	V
V _{IHD} ⁽⁵⁾	Minimum HIGH Level Dynamic Input Voltage	$C_L = 50 pF$	5.0		2.0	V
V _{ILD} ⁽⁵⁾	Maximum LOW Level Dynamic Input Voltage	$C_L = 50 pF$	5.0		0.8	V

Note:

5. Parameter guaranteed by design.

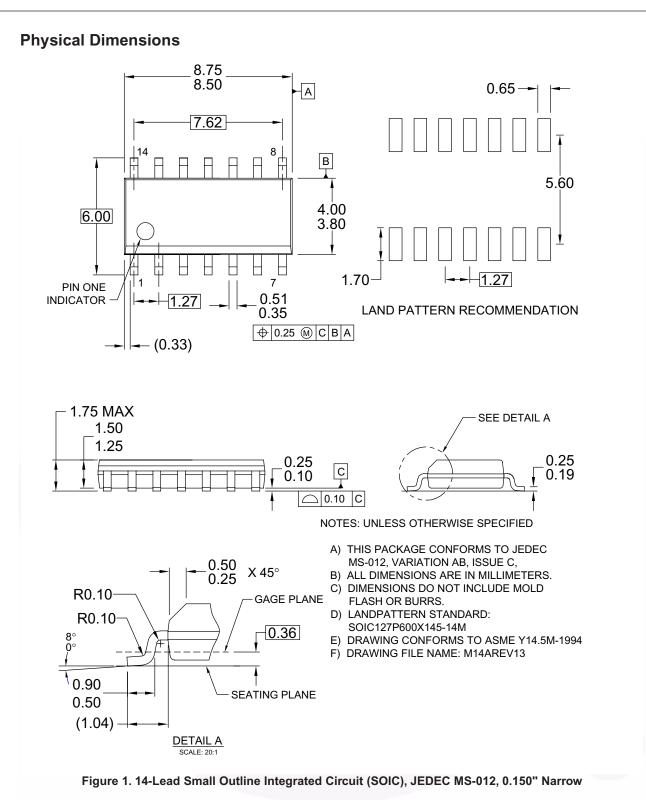
AC Electrical Characteristics

				T _A = 25°C		T _A = -40°C to +85°C			
Symbol	Parameter	V _{CC} (V)	Conditions	Min.	Тур.	Max.	Min.	Max.	Units
t _{PLH} , t _{PHL}	Propagation Delay	5.0 ± 0.5	$C_L = 15 pF$		5.0	6.9	1.0	8.0	ns
			$C_L = 50 pF$		5.5	7.9	1.0	9.0	
CIN	Input Capacitance		V _{CC} = Open		4	10		10	pF
C _{PD}	Power Dissipation Capacitance		(6)		17				pF

Note:

6. C_{PD} is defined as the value of the internal equivalent capacitance, which is calculated from the operating current consumption without load. Average operating current can be obtained from the equation: I_{CC} (Opr.) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 4$ (per gate)



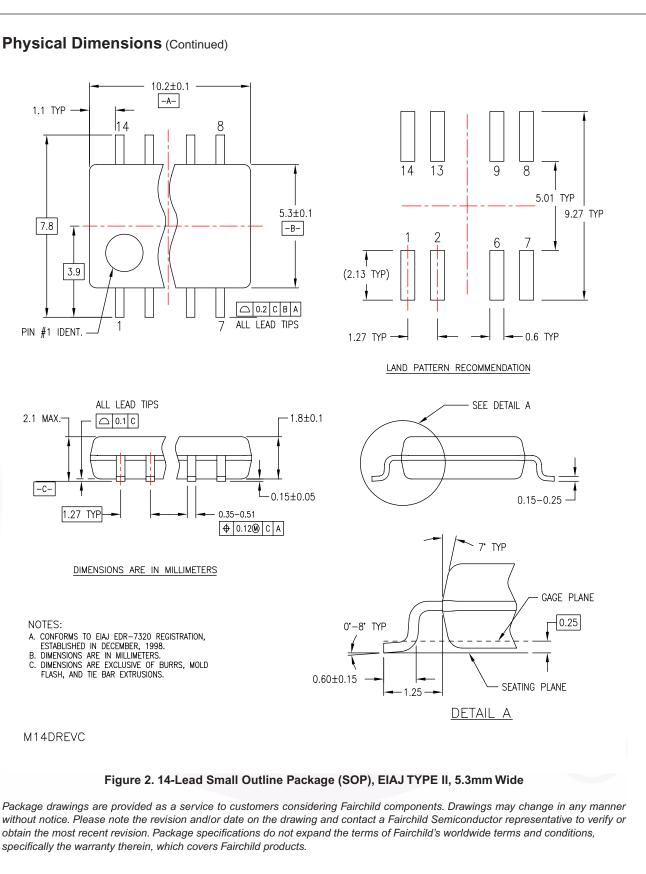


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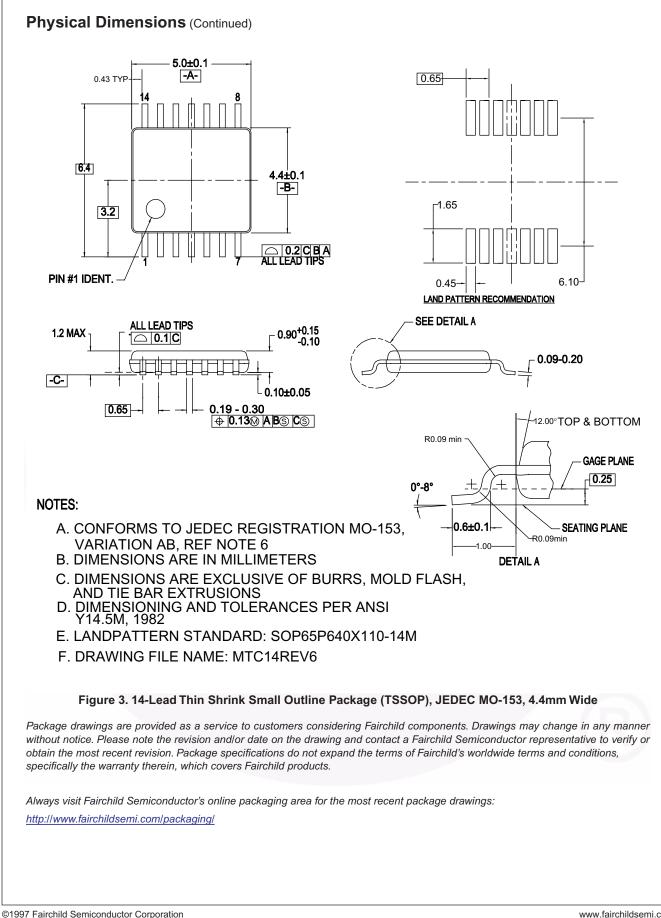


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